

-100V_{DS}/±20V_{GS} P-Channel Enhancement Mode MOSFET

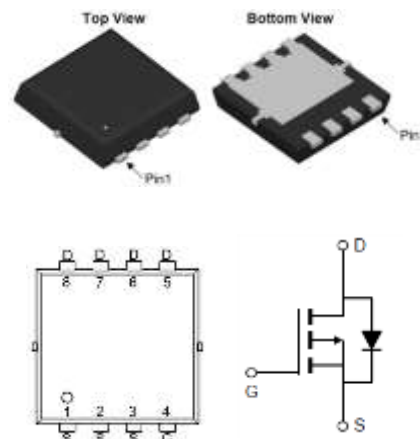
Features

- $V_{DS}=-100V, I_D=-15A$
- $R_{DS(ON)}=100m\Omega$ (TYP.) $V_{GS}=-10V$
- Reliable and Rugged
- Avalanche Rated
- Low On-Resistance
- High Current Capability

Applications

- Load Switch
- Power management in portable/desktop PCs
- DC/DC conversion

PDFN3333



Ordering Information

Device	Package		Marking	Package Qty.
AGM01P15AP	PDFN3*3	Pb-Free	**	5000pcs/Reel

Absolute Maximum Ratings ($T_C=25^{\circ}C$, unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage ($V_{GS}=0V$)	V_{DS}	-100	V
Gate-Source Voltage ($V_{GS}=0V$, static)	V_{GS}	±20	V
Continuous Drain Current ($T_C=25^{\circ}C$)	I_D	-15	A
Continuous Drain Current ($T_C=100^{\circ}C$)		9	A
Pulsed Drain Current	I_{DM}	-55	A
Avalanche Energy, Single Pulsed	E_{AS}	120	mJ
Maximum Power Dissipation ($T_C=25^{\circ}C$)	P_D	70	W
Operating, Storage Temperature Range	T_J, T_{STG}	-55~150	$^{\circ}C$

Electrical Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A$	-100	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-30V, V_{GS}=0V$	-	-	-1	μA
Gate -Source Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1.0	-1.5	-2.5	V
Drain-Source On-stage Resistance	$R_{DS(ON)}$	$V_{GS}=-10V, I_D=-1A$	-	-	100	m Ω
		$V_{GS}=-4.5V, I_D=-1A$	-	-	125	

Thermal Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal Resistance,Junction-to-Case	$R_{\theta JC}$	-	2.1	-	$^{\circ}\text{C}/\text{W}$
Thermal Resistance,Junction-to-Ambient	$R_{\theta JA}$	-	-	-	$^{\circ}\text{C}/\text{W}$

Dynamic Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Input capacitance	C_{iss}	$V_{DS}=-15\text{V}$	-	3699	-	pF
Output capacitance	C_{oss}	$V_{GS}=0\text{V}$	-	89	-	
Reverse transfer capacitance	C_{rss}	$f=1\text{MHz}$	-	31	-	
Total Gate Charge	Q_g	$V_{DS}=-15\text{V}$	-	71	-	nC
Gate Source Charge	Q_{gs}	$V_{GS}=-10\text{V}$	-	8.3	-	
Gate Drain Charge	Q_{gd}	$I_D=-15\text{A}$	-	17.2	-	
Turn-on delay Time	$t_{d(on)}$	$V_{GS}=-10\text{V}$	-	5	-	ns
Rise time	t_r	$V_{DS}=-15\text{V}$	-	28	-	
Turn-off delay Time	$t_{d(off)}$	$R_L=1\Omega$	-	16	-	
Fall time	t_f	$R_G=3\Omega$	-	23	-	

Reverse Diode Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Body Diode Forward Voltage	V_{SD}	$V_{GS}=0\text{V}, I_{SD}=-1\text{A}$	-	-	-1.2	V
Reverse Recovery Time	t_{rr}	$V_{GS}=0\text{V}, I_{SD}=-15\text{A}$	-	27	-	ns
Reverse Recovery Charge	Q_{rr}	$d_i/d_t=100\text{A}/\mu\text{s}$	-	32	-	nC

Electrical Characteristics Diagrames

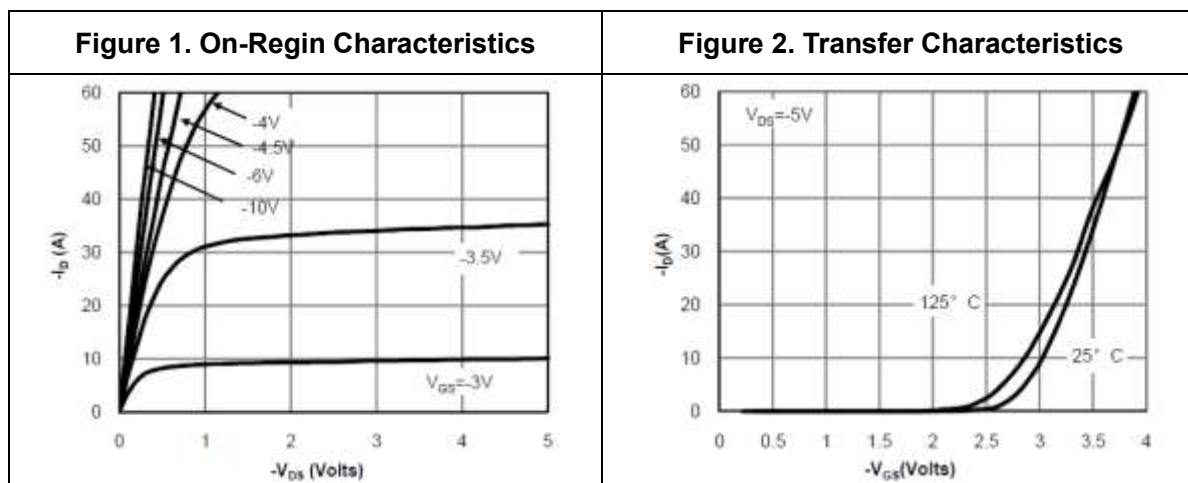


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

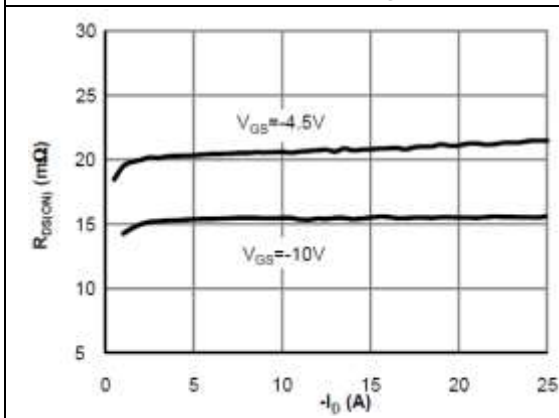


Figure 4. On-Resistance vs. Junction Temperature

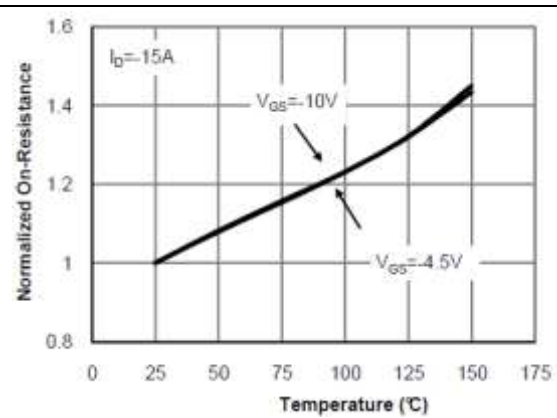


Figure 5. On-Resistance vs. Gate-Source Voltage

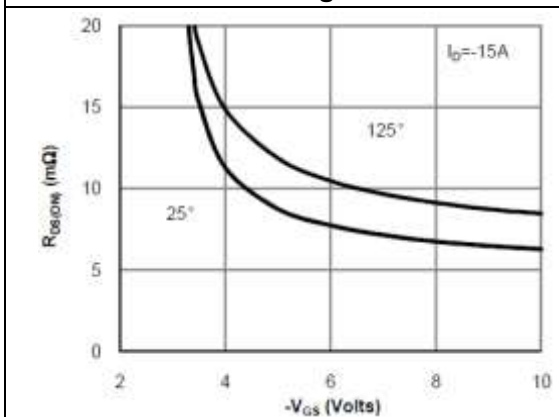


Figure 6. Body-Diode Characteristics

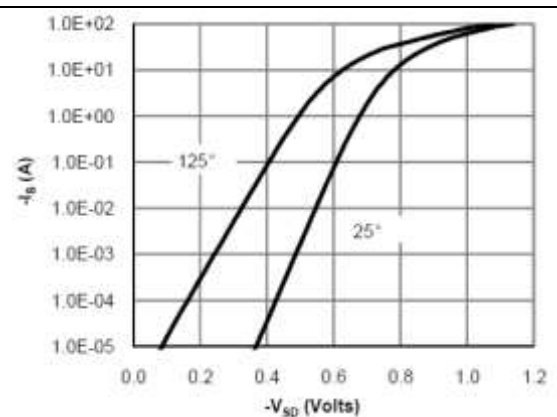


Figure 7. Gate-Charge Characteristics

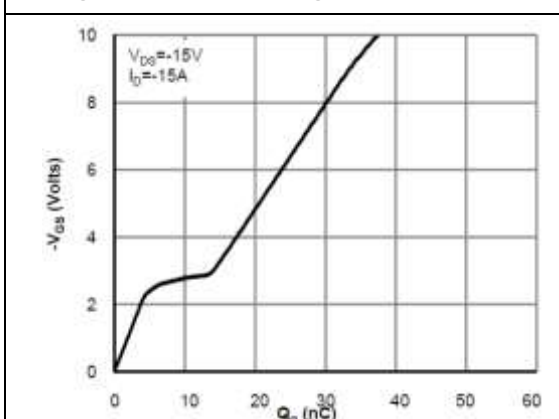


Figure 8. Capacitance Characteristics

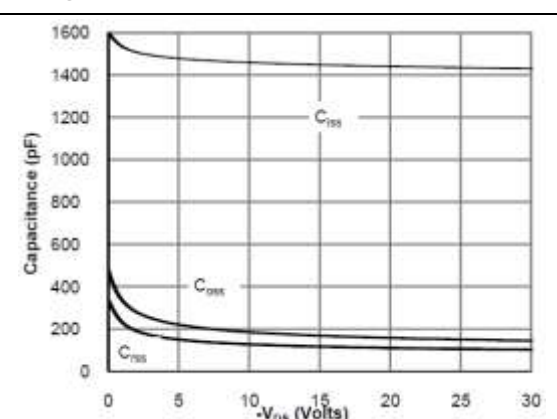


Figure 9. Maximum Forward Biased Safe Operating Area

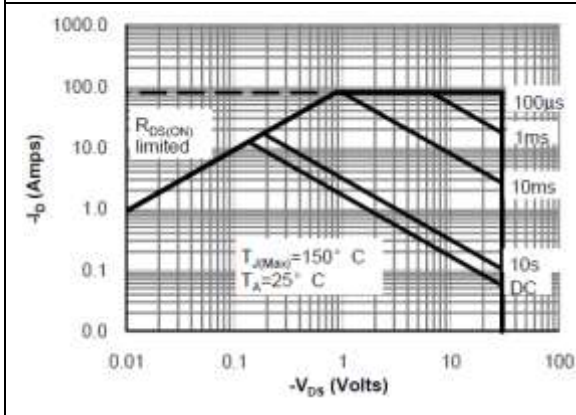


Figure 10. Single Pulse Power Rating Junction-to-Ambient

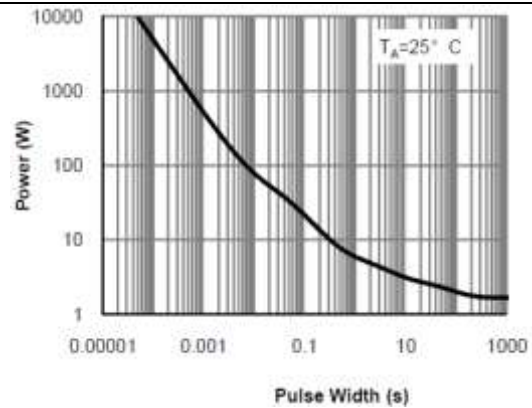
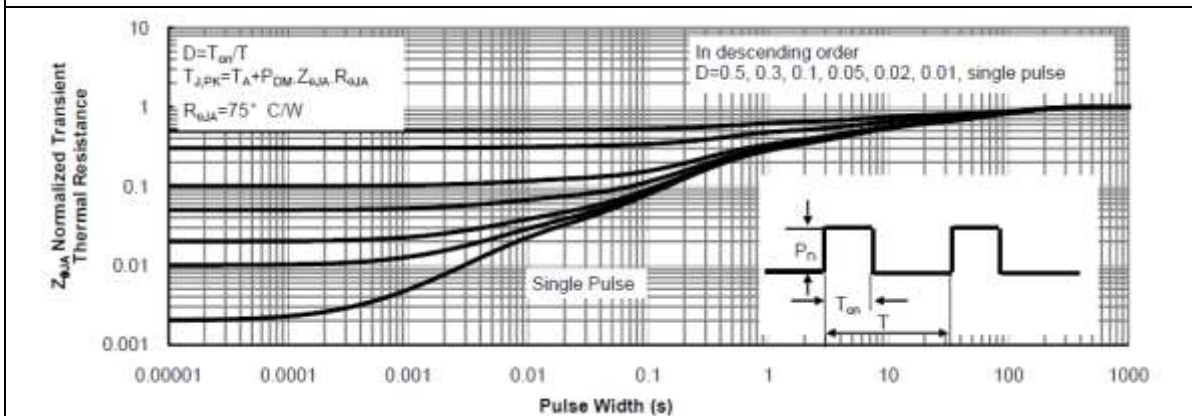
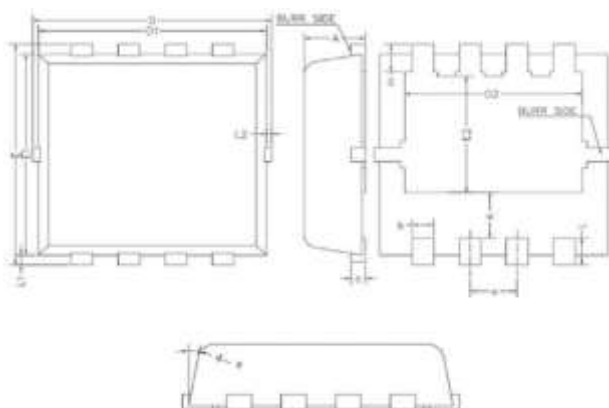


Figure 11. Normalized Maximum Transient Thermal Impedance



Physical Dimensions

PDFN3333



符号	尺寸 (mm)			符号	尺寸 (mm)		
	最小值	典型值	最大值		最小值	典型值	最大值
A	0.70	0.80	0.90	E1	2.90	3.00	3.10
b	0.25	0.30	0.35	E2	1.64	1.74	1.84
c	0.14	0.15	0.20	H	0.32	0.42	0.52
D	3.10	3.30	3.50	K	0.59	0.69	0.79
D1	3.05	3.15	3.25	L	0.25	0.40	0.55
D2	2.35	2.45	2.55	L1	0.10	0.15	0.20
e	0.55	0.65	0.75	L2	-	-	0.15
E	3.10	3.30	3.50	θ	8°	10°	12°

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